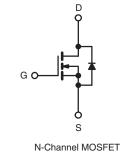




## **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.145			
Q <sub>g</sub> max. (nC)	122				
Q <sub>gs</sub> (nC)	21				
Q <sub>gd</sub> (nC)	37				
Configuration	Single				





### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP24N65E-E3
Lead (Pb)-free and Halogen-free	SiHP24N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> :	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	650	N	
Gate-Source Voltage			V <sub>GS</sub>	± 30	V	
Continuous Drain Current (T <sub>1</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	24		
Continuous Drain Current $(1) = 150^{\circ}$ C)	VGS at 10 V	T <sub>C</sub> = 100 °C		16	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	70		
Linear Derating Factor				2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	508	mJ	
Maximum Power Dissipation			PD	250	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		al) / / alt	37		
Reverse Diode dV/dt d			dV/dt	11	V/ns	
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s			300	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 28.2 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 6$  A.

c. 1.6 mm from case. d.  $I_{SD} \le I_D$ , dl/dt = 100 A/µs, starting  $T_J = 25$  °C.

1 For technical questions, contact: hvm@vishay.com



FREE



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	0.0							
PARAMETER	SYMBOL	TYP.		<b>MAX.</b> 62		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-				°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 0.5			0/11			
SPECIFICATIONS (T <sub>J</sub> = 25 °C, 1	unless otherwi	se noted)						
PARAMETER	SYMBOL	1	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static							I	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> =	250 µA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$			I <sub>D</sub> = 250 μA	-	0.72	-	V/°(
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> =	250 μA	2	-	4	V
		$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		-	-	± 100	nA	
Gate-Source Leakage	I <sub>GSS</sub>			-	-	± 1	μA	
		V <sub>DS</sub> =	= 650 V, V <sub>G</sub>	<sub>is</sub> = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$ $I_D = 12 A$		-	0.120	0.145	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 8 V, I <sub>D</sub> = 5 A		-	7.1	-	S	
Dynamic	•	•			•	•	•	•
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2740	-	pF	
Output Capacitance	C <sub>oss</sub>			-	122	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	4	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	– V <sub>DS</sub> = 0 V to 520 V, V <sub>GS</sub> = 0 V		-	93	-		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	352	-		
Total Gate Charge	Qq				-	81	122	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 12	A, V <sub>DS</sub> = 520 V	-	21	-	
Gate-Drain Charge	Q <sub>gd</sub>				-	37	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	24	48	
Rise Time	t <sub>r</sub>	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 12 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	84	126	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	70	105		
Fall Time	t <sub>f</sub>			-	69	104		
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	0.68	-	Ω	
Drain-Source Body Diode Characterist	cs							
Continuous Source-Drain Diode Current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	70	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 12 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>				-	433	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 2$	5 °C, I <sub>F</sub> = I <sub>s</sub> 100 A/µs,	$_{\rm S} = 12  {\rm A},$	-	7.3	-	μΟ
Reverse Recovery Current	I <sub>RRM</sub>		του AvµS,	$v_{\rm R} = 20 v$	-	28	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b. C<sub>oss(tr)</sub> is a fixed capacitance that gives the same charging time as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 % to 80 % V<sub>DSS</sub>.



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

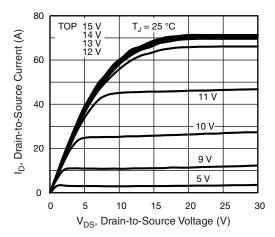


Fig. 1 - Typical Output Characteristics

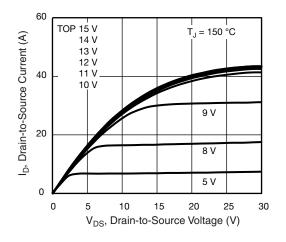
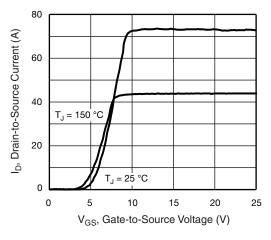


Fig. 2 - Typical Output Characteristics





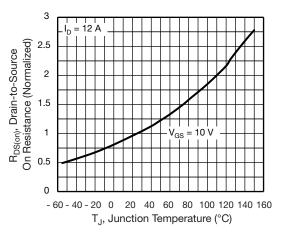


Fig. 4 - Normalized On-Resistance vs. Temperature

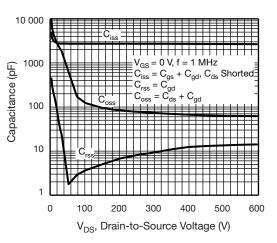
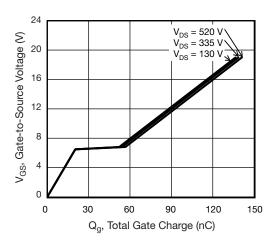
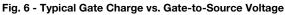


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





S15-0291-Rev. G, 23-Feb-15

**3** For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91475

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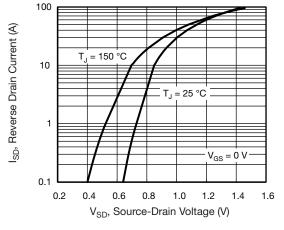


Fig. 7 - Typical Source-Drain Diode Forward Voltage

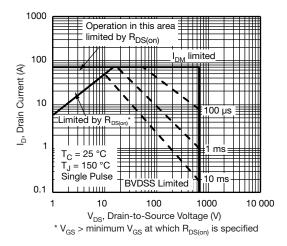


Fig. 8 - Maximum Safe Operating Area

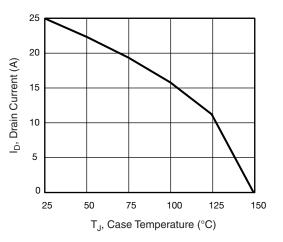


Fig. 9 - Maximum Drain Current vs. Case Temperature

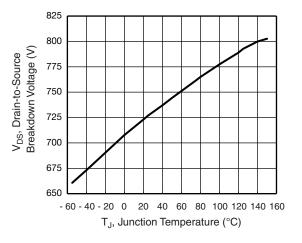
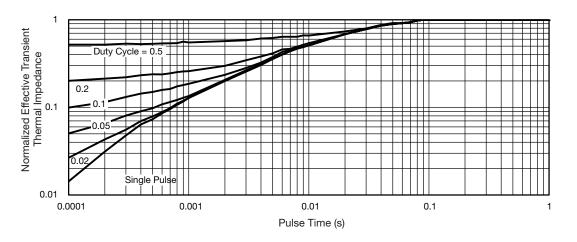


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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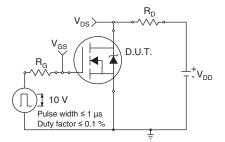


Fig. 12 - Switching Time Test Circuit

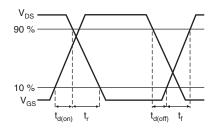


Fig. 13 - Switching Time Waveforms

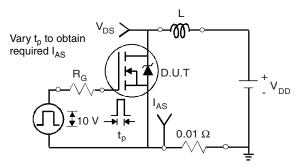


Fig. 14 - Unclamped Inductive Test Circuit

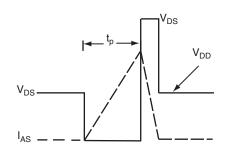
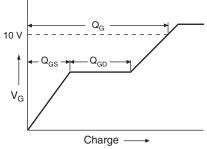


Fig. 15 - Unclamped Inductive Waveforms



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Fig. 16 - Basic Gate Charge Waveform

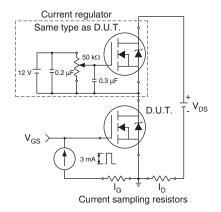


Fig. 17 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

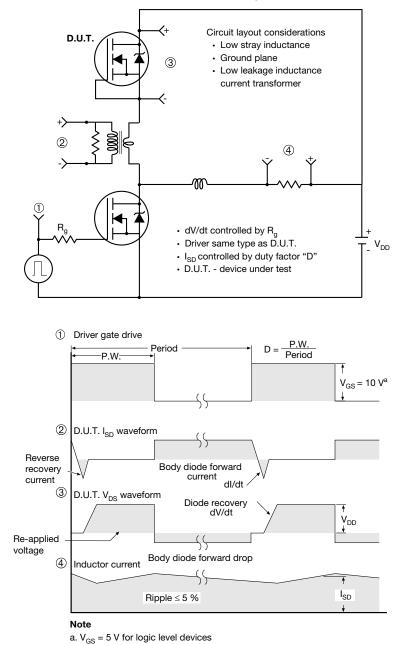


Fig. 18 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

#### Note

• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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